



650.00698
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Reissue Application of:) THERMOPLASTIC ELASTOMER
HIROHIDE ENAMI et al) COMPOSITION FOR POWDER
Reissue U.S. Patent No. 5,948,850) SLUSH MOLDING AND PROCESS
Serial No. 09/815,414) FOR PREPARATION OF
Filed March 22, 2001) SAID COMPOSITION
)
) Group Art Unit 1712
)
) Examiner David E. Aylward

SUBMISSION OF ORIGINAL LETTERS PATENT

Box REISSUE
Commissioner for Patents
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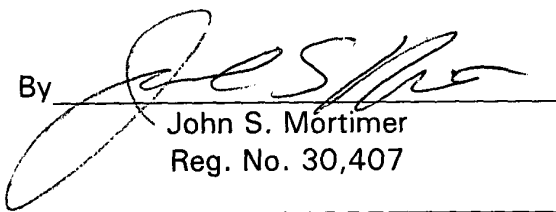
Sir:

Submission of the original U.S. Letters Patent 5,948,850, in accordance with 37 C.F.R. 1.178, is being deferred, pending allowance of this reissue application.

Respectfully submitted,

WOOD, PHILLIPS, KATZ,
CLARK & MORTIMER

By


John S. Mortimer
Reg. No. 30,407

January 21, 2003

500 West Madison Street
Suite 3800
Chicago, IL 60661-2511
(312) 876-1800

37 CFR 1.8
CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Box REISSUE, Commissioner for Patents, Washington, D.C. 20231, on January 21, 2003.

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Name:

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